

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5526475

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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Property Type	Number
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Total Attachments: 3	
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ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name _____ (City and State OR Country)
 Takayasu Otagaki Ota Japan
 Kensuke Goto Ashikaga Japan

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Title: METHODS AND APPARATUS FOR A CAPACITIVE SENSOR

Attorney Docket No.: ONS03176P01US

Serial No.: US 16/413967

Filing Date: May 16, 2019

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

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(市及び州又は国) _____ の (氏名) _____
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所有権: METHODS AND APPARATUS FOR A CAPACITIVE SENSOR

代理人明細書番号: ONS03176P01US

シリアル番号: US 16/413967

申請日: May 16, 2019

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署名及び認証日: May 16, 2019

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